

LNPTTM THERMOCOMPTM COMPOUND DZ004

DF-1004 M
REGION AMERICAS

DESCRIPTION

LNP THERMOCOMP DZ004 compound is based on Polycarbonate (PC) resin containing 20% milled glass.

GENERAL INFORMATION	
Features	Low Warpage, High stiffness/Strength, No PFAS intentionally added
Fillers	Milled Glass Fiber
Polymer Types	Polycarbonate (PC)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Building and Construction	Building Component
Consumer	Personal Accessory
Electrical and Electronics	Mobile Phone - Computer - Tablets
Industrial	Electrical

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, break	60	MPa	ASTM D638
Tensile Strain, break	4.5	%	ASTM D638
Tensile Modulus, 50 mm/min	3700	MPa	ASTM D638
Flexural Stress	96	MPa	ASTM D790
Flexural Modulus	3500	MPa	ASTM D790
IMPACT ⁽¹⁾			
Izod Impact, unnotched, 23°C	1142	J/m	ASTM D4812
Izod Impact, notched, 23°C	58	J/m	ASTM D256
THERMAL ⁽¹⁾			
HDT, 1.82 MPa, 3.2mm, unannealed	136	°C	ASTM D648
Relative Temp Index, Elec ⁽²⁾	125	°C	UL 746B
Relative Temp Index, Mech w/impact ⁽²⁾	115	°C	UL 746B
Relative Temp Index, Mech w/o impact ⁽²⁾	125	°C	UL 746B
PHYSICAL ⁽¹⁾			
Density	1.41	g/cm ³	ASTM D792
Mold Shrinkage, flow, 24 hrs ⁽³⁾	0.3	%	ASTM D955
ELECTRICAL ⁽¹⁾			
Hot-Wire Ignition (HWI), PLC 0	≥1.5	mm	UL 746A
High Amp Arc Ignition (HAI), PLC 2	≥3	mm	UL 746A

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
High Amp Arc Ignition (HAI), PLC 4	≥1.5	mm	UL 746A
High Voltage Arc Track Rate {PLC}	4	PLC Code	UL 746A
FLAME CHARACTERISTICS ⁽²⁾			
UL Yellow Card Link	E121562-101357493	-	-
UL Recognized, 94V-1 Flame Class Rating	≥3	mm	UL 94
UL Recognized, 94V-2 Flame Class Rating	≥1.5	mm	UL 94
INJECTION MOLDING ⁽⁴⁾			
Drying Temperature	120	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	305 – 325	°C	
Front - Zone 3 Temperature	320 – 330	°C	
Middle - Zone 2 Temperature	310 – 320	°C	
Rear - Zone 1 Temperature	295 – 305	°C	
Mold Temperature	80 – 110	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.
- (3) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.

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